

08/08/03

RELIABILITY REPORT FOR

DS3905, Rev A1

Dallas Semiconductor

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Prepared by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products and processes:

DS3905, Rev A1

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts AfT = Acceleration factor due to Temperature tu = Time at use temperature (e.g. 55°C) ts = Time at stress temperature (e.g. 125°C) k = Boltzmann's Constant (8.617 x 10-5 eV/°K) Tu = Temperature at Use (°K) Ts = Temperature at Stress (°K) Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

AfV = exp(B*(Vs - Vu)) AfV = Acceleration factor due to Voltage Vs = Stress Voltage (e.g. 7.0 volts) Vu = Maximum Operating Voltage (e.g. 5.5 volts) B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

Fr = X/(ts * AfV * AfT * N * 2)X = Chi-Sq statistical upper limit N = Life test sample size Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE:	MTTF (YRS): 18615	FITS: 6.1
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The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0	Tu: 25 °C	Vu: 5.5 Volts
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The reliability data follows. A the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available.

Device Information:

Process: Passivation:	D6W-2P2M,HPVt,E2,EPROGVt,TCZ ALOCOS:GOI Passivation w/Nov TEOS Oxide-Nitride
Die Size:	58 x 89
Number of Transistors:	3000
Interconnect:	Aluminum / 1% Silicon / 0.5% Copper
Gate Oxide Thickness:	150 Å

ELECTRICAL CHARACTERIZATION

DESCRIPTION	DATE COD	E CONDITION	REA	DPOINT	QUANTITY	FAILS
ESD SENSITIVITY	0309	EOS/ESD S5.1 HBM 500 VOLTS	1	PUL'S	3	0
ESD SENSITIVITY	0309	EOS/ESD S5.1 HBM 1000 VOLTS	1	PUL'S	3	0
ESD SENSITIVITY	0309	EOS/ESD S5.1 HBM 2000 VOLTS	1	PUL'S	3	0
ESD SENSITIVITY	0309	EOS/ESD S5.1 HBM 4000 VOLTS	1	PUL'S	3	3
ESD SENSITIVITY	0309	EOS/ESD S5.1 HBM 8000 VOLTS	1	PUL'S	3	3
LATCH-UP	0309	JESD78, I-TEST 125C			6	0
LATCH-UP	0309	JESD78, Vsupply TEST 125C			6	0
				То	tal:	6

DESCRIPTION	DATE CODE	CONDITION	REAL	POINT	QUANTITY	FAILS	
HIGH VOLTAGE LIFE	0251	125C, 6.0 VOLTS	1000	HRS	45	0	
HIGH VOLTAGE LIFE	0305	125C, 6.0 VOLTS	1000	HRS	45	0	
HIGH TEMP OP LIFE	0315	125C, 5.5 VOLTS	1000	HRS	45	0	
HIGH TEMP OP LIFE	0325	125C, 5.5 VOLTS	192	HRS	77	0	
HIGH VOLTAGE LIFE	0327	125C, 5.5 VOLTS	192	HRS	45	0	
				Tot	tal:	0	

STORAGE LIFE

DESCRIPTION	DATE CODE	CONDITION	READPOINT	QUANTITY	FAILS
STORAGE LIFE	0305	150C	1000 HRS	77	0

Total:

W/E ENDURANCE AND DATA RET'N							
DESCRIPTION	DATE CODE	E CONDITION		REAI	OPOINT	QUANTITY	FAILS
WRITE CYCLE STRESS STORAGE LIFE	0251	70 C, 6.0 VOLTS 150C		30 1000	KCYS HRS	77 77	0 0
WRITE CYCLE STRESS STORAGE LIFE	0315	70 C, 5.5 VOLTS 150C		30 96	KCYS HRS	77 77	0 0
WRITE CYCLE STRESS STORAGE LIFE	0325	85 C, 5.5 VOLTS 150C		30 96	KCYS HRS	77 76	0 0
WRITE CYCLE STRESS STORAGE LIFE	0327	70 C, 5.5 VOLTS 150C		30 96	KCYS HRS Tot	77 77 al:	0 0 0
FAILURE RATE:	мтт	F (YRS): 18615	FITS: 6	.1			